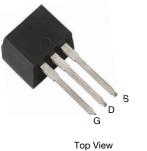
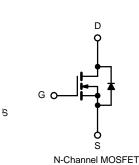


N-Channel 80 V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | |
|---------------------|-----------------------------------|--------------------|-----------------------|--|--|
| V _{DS} (V) | R _{DS(on)} (Ω) Max. | I _D (A) | Q _g (Typ.) | | |
| | 0.0064 at V_{GS} = 10 V | 85 ^a | | | |
| 80 | 0.0070 at V_{GS} = 6.0 V | 80 ^a | 17.1 nC | | |
| | 0.0087 at V _{GS} = 4.5 V | 60 ^a | | | |

TO-262





FEATURES

- TrenchFET[®] Power MOSFET
- 100 % $\rm R_{g}$ and UIS Tested

APPLICATIONS

- Primary Side Switching
- Synchronous Rectification
- DC/AC Inverters
- LED Backlighting



| Parameter | Symbol | Limit | Unit | | |
|--|------------------------|-----------------------------------|----------------------|-----|--|
| Drain-Source Voltage | V _{DS} | 80 | V | | |
| Gate-Source Voltage | | V _{GS} | ± 20 | v | |
| | T _C = 25 °C | | 85 ^a | | |
| Continuous Drain Current (T. 150 °C) | T _C = 70 °C | | 65 | | |
| Continuous Drain Current (T _J = 150 °C) | T _A = 25 °C | I _D | 28.6 ^{b, c} | | |
| | T _A = 70 °C | | 24.9 ^{b, c} | | |
| Pulsed Drain Current (t = 100 μs) | | I _{DM} | 250 | — A | |
| Continuous Courses Dusia Diada Courset | T _C = 25 °C | | 85 | | |
| Continuous Source-Drain Diode Current | T _A = 25 °C | I _S | 4.5 ^{b, c} | | |
| Single Pulse Avalanche Current | | I _{AS} | 30 | | |
| Single Pulse Avalanche Energy | L = 0.1 mH | E _{AS} | 45 | mJ | |
| | T _C = 25 °C | | 62.5 | | |
| Maximum Davier Diasia atian | T _C = 70 °C | | 40 | 14/ | |
| Maximum Power Dissipation | T _A = 25 °C | P _D | 5 ^{b, c} | W | |
| | T _A = 70 °C | | 3.2 ^{b, c} | | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to 150 | | |
| Soldering Recommendations (Peak Temperature | | 260 | | | |

| THERMAL RESISTANCE RATINGS | | | | | | | |
|---|--------------|-------------------|---------|---------|------|--|--|
| Parameter | | Symbol | Typical | Maximum | Unit | | |
| Maximum Junction-to-Ambient ^{b, f} | t ≤ 10 s | R _{thJA} | 20 | 25 | °C/W | | |
| Maximum Junction-to-Case (Drain) | Steady State | R _{thJC} | 1.5 | 2.0 | 0/11 | | |

Notes

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

- d. The TO-220 is a leadless package. The end of the lead terminal is exposed
- copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

f. Maximum under steady state conditions is 70 °C/W.

VBN1806

| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
|--|-------------------------|--|------|--------|-------|-------|--|
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$ | 80 | | | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | L 050 A | | 37 | | mV/°C | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | I _D = 250 μA | | - 6.1 | | | |
| Gate-Source Threshold Voltage | V _{GS(th}) | $V_{DS} = V_{GS}, I_D = 250 \ \mu A$ | 1.4 | | 2.6 | V | |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 20 V$ | | | ± 100 | nA | |
| 7 | I _{DSS} | $V_{DS} = 80 \text{ V}, V_{GS} = 0 \text{ V}$ | | | 1 | μA | |
| Zero Gate Voltage Drain Current | | V _{DS} = 80 V, V _{GS} = 0 V, T _J = 55 °C | | | 10 | | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 5 V$, $V_{GS} = 10 V$ | 30 | | | А | |
| | | $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$ | | 0.0064 | | | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = 6 V, I _D = 15 A | | 0.0070 | | Ω | |
| | | $V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$ | | 0.0087 | | | |
| Forward Transconductance ^a | g _{fs} | V _{DS} = 10 V, I _D = 20 A | | 60 | | S | |
| Dynamic ^b | | | | | | | |
| Input Capacitance | C _{iss} | | | 2855 | | | |
| Output Capacitance | C _{oss} | V _{DS} = 40 V, V _{GS} = 0 V, f = 1 MHz | | 950 | | pF | |
| Reverse Transfer Capacitance | C _{rss} | | | 276 | | | |
| Total Gate Charge | Q _g | $V_{DS} = 40 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$ | | 35.5 | 54 | - nC | |
| | | $V_{DS} = 40 \text{ V}, V_{GS} = 6 \text{ V}, I_D = 10 \text{ A}$ | | 22 | 33 | | |
| - | | | | 17.1 | 26 | | |
| Gate-Source Charge | Q _{gs} | $V_{DS} = 40 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$ | | 5.3 | | | |
| Gate-Drain Charge | Q _{gd} | | | 7.3 | | | |
| Output Charge | Q _{oss} | $V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$ | | 57 | 86 | | |
| Gate Resistance | R _g | f = 1 MHz | 0.5 | 1.3 | 2 | Ω | |
| Turn-On Delay Time | t _{d(on)} | | | 12 | 24 | | |
| Rise Time | t _r | $V_{DD} = 40 \text{ V}, \text{ R}_{\text{I}} = 4 \Omega$ | | 8 | 16 | - | |
| Turn-Off DelayTime | t _{d(off)} | $I_D \cong 10 \text{ A}, V_{\text{GEN}} = 10 \text{ V}, R_g = 1 \Omega$ | | 32 | 64 | | |
| Fall Time | t _f | | | 7 | 14 | | |
| Turn-On Delay Time | t _{d(on)} | | | 14 | 28 | ns | |
| Rise Time | t _r | $V_{DD} = 40 \text{ V}, \text{ R}_{\text{I}} = 4 \Omega$ | | 11 | 22 | - | |
| Turn-Off DelayTime | t _{d(off)} | $I_D \cong 10 \text{ A}, V_{\text{GEN}} = 6.0 \text{ V}, R_g = 1 \Omega$ | | 30 | 60 | | |
| Fall Time | t _f | - | | 8 | 16 | | |
| Drain-Source Body Diode Characteristic | · · · | | | | | | |
| Continuous Source-Drain Diode Current | I _S | T _C = 25 °C | | | 75 | Ι. | |
| Pulse Diode Forward Current (t = $100 \ \mu s$) | I _{SM} | - | | | 150 | A | |
| Body Diode Voltage | V _{SD} | I _S = 5 A | | 0.76 | 1.1 | V | |
| Body Diode Reverse Recovery Time | t _{rr} | - | | 38 | 75 | ns | |
| Body Diode Reverse Recovery Charge | Q _{rr} | | | 36 | 70 | nC | |
| Reverse Recovery Fall Time | | t_a IF = 10 A, dl/dt = 100 A/µs, 1J = 25 °C | | 19 | - | - ns | |
| Reverse Recovery Rise Time | t _b | | | 19 | | | |

Notes

a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%.$

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

VBsemi Bsemi.com



- 55 °C

7.0

5.6

=

4.2

2.8

24

Capacitance

0

25

50

T_{.1} - Junction Temperature (°C)

75

100

36

 $V_{GS} = 10 V$

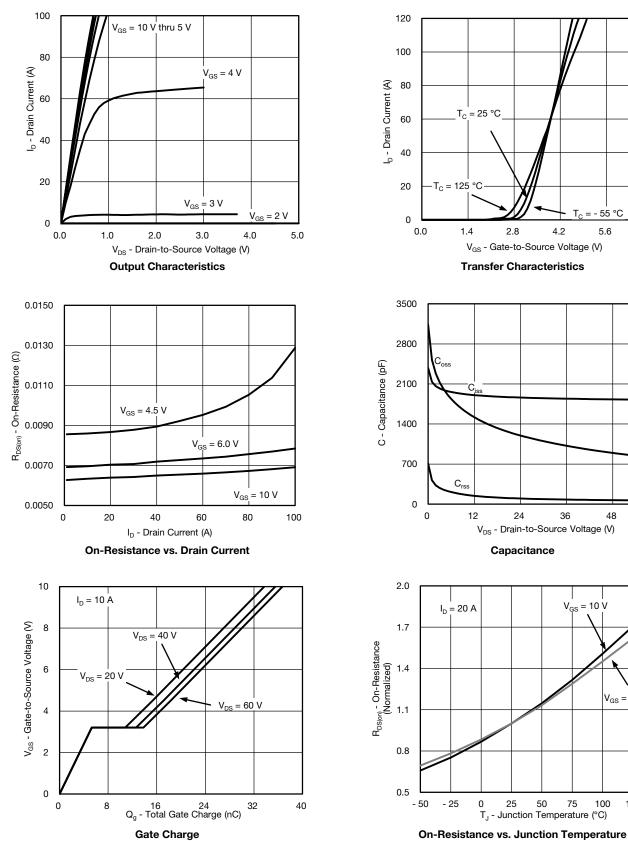
48

V_{GS} = 4.5 V

125

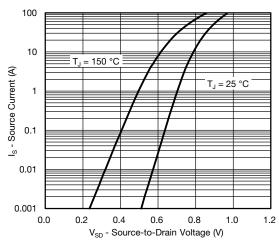
150

60

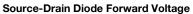


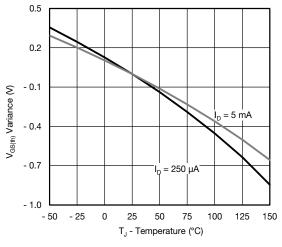
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



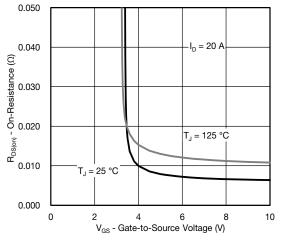


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

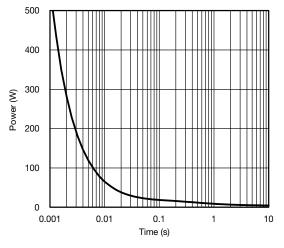




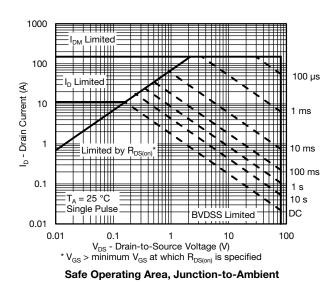




On-Resistance vs. Gate-to-Source Voltage

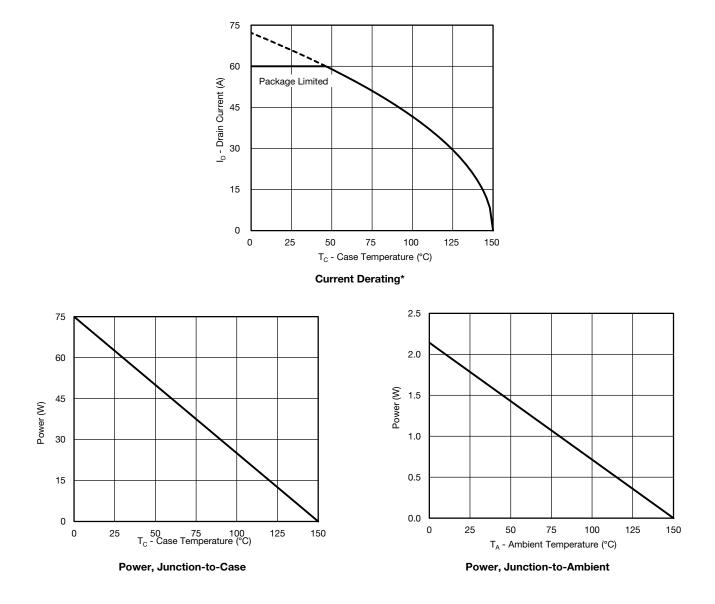


Single Pulse Power, Junction-to-Ambient





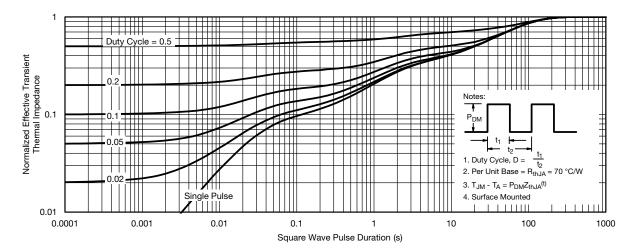
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



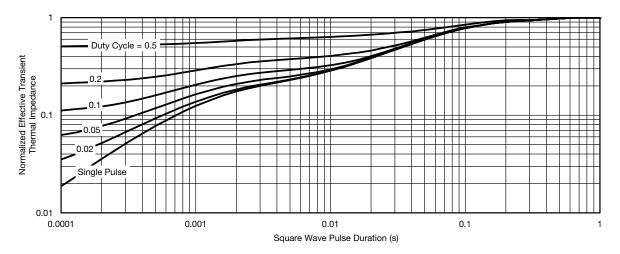
* The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



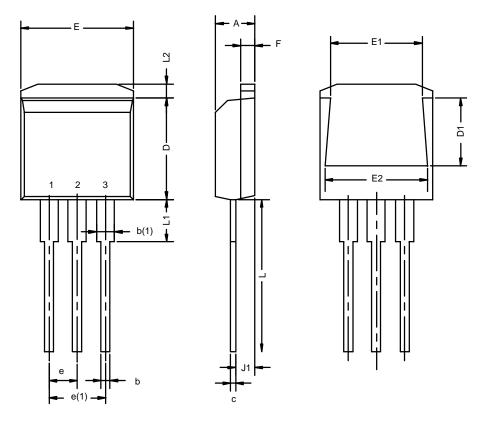




Normalized Thermal Transient Impedance, Junction-to-Case



TO-262: 3-LEAD



| | MILLIM | ETERS* | INCHES | | |
|---|--------|--------|--------|-------|--|
| Dim | Min | Max | Min | Max | |
| Α | 4.32 | 4.70 | 0.170 | 0.185 | |
| b | 0.64 | 1.00 | 0.025 | 0.039 | |
| b(1) | 1.14 | 1.40 | 0.045 | 0.055 | |
| С | 0.36 | 0.50 | 0.014 | 0.020 | |
| D | 8.64 | 9.65 | 0.340 | 0.380 | |
| D1 | 5.59 | 6.10 | 0.220 | 0.240 | |
| е | 2.41 | 2.67 | 0.095 | 0.105 | |
| e(1) | 4.95 | 5.33 | 0.195 | 0.210 | |
| E | 10.03 | 10.41 | 0.395 | 0.410 | |
| E1 | 7.87 | 8.64 | 0.310 | 0.340 | |
| E2 | 9.02 | 9.53 | 0.355 | 0.375 | |
| F | 1.14 | 1.40 | 0.045 | 0.055 | |
| J1 | 2.41 | 2.79 | 0.095 | 0.110 | |
| L | 13.08 | 14.22 | 0.515 | 0.560 | |
| L1 | - | 3.81 | - | 0.150 | |
| L2 | 1.02 | 1.40 | 0.040 | 0.055 | |
| ECN: T-02234—Rev. C, 14-Oct-02 DWG: 5855 | | | | | |

 $\ensuremath{^*\text{Use}}$ millimeters as the primary measurement



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